Special Issue

Electrospraying and Electrospinning of Live Cells

Message from the Guest Editors

An important challenge in the fabrication of tissueengineered constructs for regenerative medical
applications is the development of processes capable
of delivering cells and biomaterials to specific locations
in a consistent manner. Electrospraying and
electrospinning of live cells have been introduced
recently as cell seeding methods. Early evidence
suggests that electrospraying and electrospinning
techniques can be used to seed cells evenly in the
fabrication of fibers, and in some cases, cell
differentiation has occurred. In this Special Issue, we are
focusing on the electrospraying and electrospinning of
live cells no matter whether the cells differentiate or
keep their identity.

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Deadline for manuscript submissions

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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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